



#31

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

RECEIVED
AUG - 6 2002
TECHNOLOGY CENTER 1700

In re Application:

Serial No.: 09/322,174

Filed: May 28, 1999

July 24, 2002

Hon. Commissioner of Patents and Trademarks
Washington D.C. 20231

CHANGE OF ADDRESS

S I R:

Please address all future correspondence concerning the above application
or any patent to issue to the following:

William H. Dippert
Reed Smith LLP
599 Lexington Avenue
29th Floor
New York, New York 10022
(212) 521-5400

Customer No. 026418

COPY OF PAPERS
ORIGINALLY FILED

Respectfully submitted,

William H. Dippert
William H. Dippert
Reg. No. 26,723